SiHF12N65E

Vishay Siliconix



PRODUCT SUMMARY

V_{DS} (V) at T_J max.

Q_q max. (nC)

Configuration

Q_{gs} (nC) Q_{gd} (nC)

R_{DS(on)} max. (Ω) at 25 °C

GDS

TO-220 FULLPAK

E Series Power MOSFET

S

N-Channel MOSFET

0.38

700

70

9

16

Single

V_{GS} = 10 V



- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free and Halogen-free	SiHF12N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	650	v
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Drain Current (T ₁ = 150 °C) $^{\circ}$	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I_	12	
Continuous Drain Current $(T_j = 150^{\circ} C_j)^2$	V _{GS} at 10 V	T _C = 100 °C	ID	8	А
Pulsed Drain Current ^a			I _{DM}	28	
Linear Derating Factor				0.26	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	226	mJ
Maximum Power Dissipation			PD	33	W
Operating Junction and Storage Temperature Range	е		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	T _J = 125 °C		dV/dt	37	V/ns
Reverse Diode dV/dt d			uv/ui	28	v/11S
Soldering Recommendations (Peak temperature) ^c	For	10 s		300	°C
Mounting Torque	M3 s	screw		0.6	Nm

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

e. Limited by maximum junction temperature.

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		65			00 AM	
Maximum Junction-to-Case (Drain)	R _{thJC}	-		3.8			°C/W	
	•	•						
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 µA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.78	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$= V_{GS}, I_D =$	250 µA	2	-	4	V
Osta Caura Laskana			$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 6 \text{ A}$	V	-	-	± 1	μA	
Zene Osta Malta na Draia Ormant		V _{DS} =	= 650 V, V _G	_{is} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	$\begin{array}{c c} V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V} \\ \hline V_{DS} = 520 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \\ \hline \text{S(on)} & \text{V}_{GS} = 10 \text{ V} & \text{I}_{D} = 6 \text{ A} \\ \hline \text{Ofs} & \text{V}_{DS} = 30 \text{ V}, \text{ I}_{D} = 6 \text{ A} \\ \hline \hline \text{Ofs} & \text{V}_{DS} = 30 \text{ V}, \text{ I}_{D} = 6 \text{ A} \\ \hline \hline \text{Ofs} & \text{V}_{GS} = 0 \text{ V}, \\ \hline \text{V}_{DS} = 100 \text{ V}, \\ \hline \text{V}_{SS} = 10 \text{ V}, \\ \hline \text{V}_{SS} = 1$	/, T _J = 125 °C	-	-	10	μA	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$		I _D = 6 A	-	0.33	0.38	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D	= 6 A	-	3.5	-	S
Dynamic					•	•		
Input Capacitance	C _{iss}	$V_{DS} = 100 V,$		-	1224	-	-	
Output Capacitance	C _{oss}			-	65	-		
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		-	4	-	1
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{\rm DS}$ = 0 V to 520 V, $V_{\rm GS}$ = 0 V		-	50	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	160	-		
Total Gate Charge	Qg				-	35	70	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 6 /	A, V _{DS} = 520 V	-	9	-	nC
Gate-Drain Charge	Q _{gd}				-	16	-	
Turn-On Delay Time	t _{d(on)}				-	16	32	
Rise Time	t _r	- V _{DD} :	V_{DD} = 520 V, I_D = 6 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	19	38	- ns
Turn-Off Delay Time	t _{d(off)}				-	35	70	
Fall Time	t _f				-	18	36	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.81	-	Ω	
Drain-Source Body Diode Characteristic	-	•			•			
Continuous Source-Drain Diode Current	I _S	MOSFET syml showing the	bol		-	-	12	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction			-	-	28	A
Diode Forward Voltage	V _{SD}	T.1 = 25 °	C, I _S = 6 A	, V _{GS} = 0 V	-	1.0	1.2	V
Reverse Recovery Time	t _{rr}				-	309	618	ns
		$T_J = 25 \text{ °C}, I_F = I_S = 6 \text{ A},$ dl/dt = 100 A/µs, V _R = 25 V		-	3.8	7.6	μC	
Reverse Recovery Charge	Q _{rr}		100 1	0514	-	3.0	1.0	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

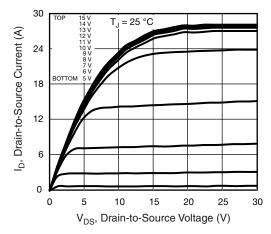


Fig. 1 - Typical Output Characteristics

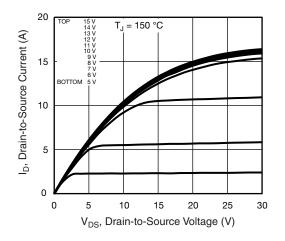


Fig. 2 - Typical Output Characteristics

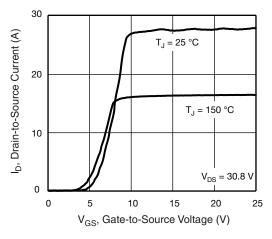


Fig. 3 - Typical Transfer Characteristics

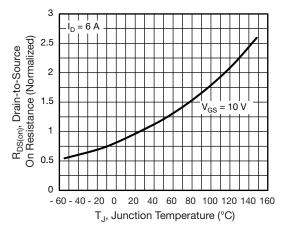


Fig. 4 - Normalized On-Resistance vs. Temperature

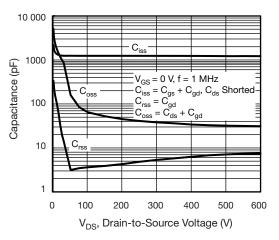
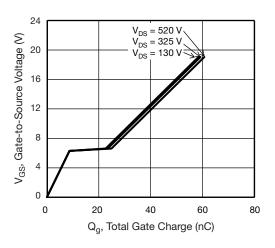


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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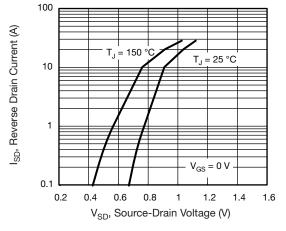


Fig. 7 - Typical Source-Drain Diode Forward Voltage

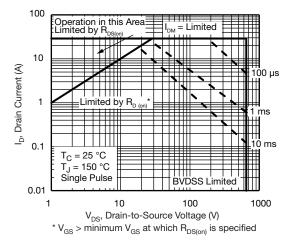


Fig. 8 - Maximum Safe Operating Area

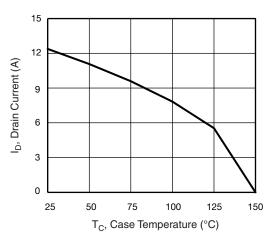


Fig. 9 - Maximum Drain Current vs. Case Temperature

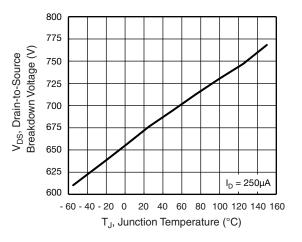
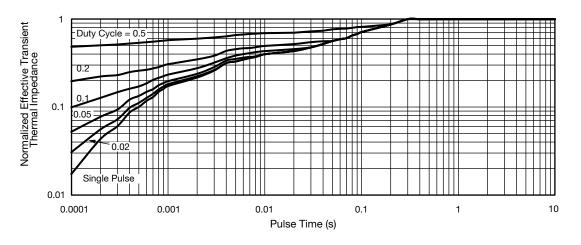


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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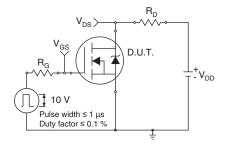


Fig. 12 - Switching Time Test Circuit

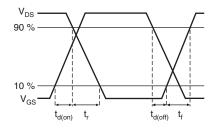


Fig. 13 - Switching Time Waveforms

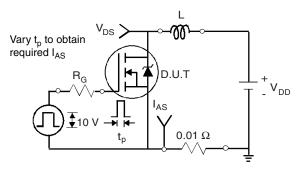


Fig. 14 - Unclamped Inductive Test Circuit

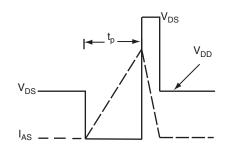


Fig. 15 - Unclamped Inductive Waveforms

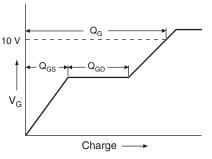


Fig. 16 - Basic Gate Charge Waveform

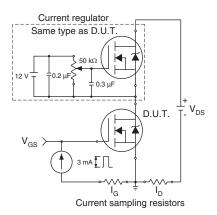


Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

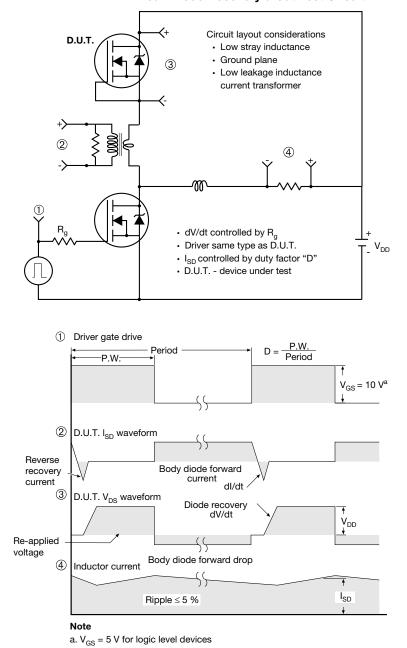


Fig. 18 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

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OPTION 2: FACILITY CODE = Y



	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
С	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
E	10.360	10.630	0.408	0.419
е	2.54	BSC	0.100) BSC
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
ØP	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
V	0.400	0.500	0.016	0.020

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

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